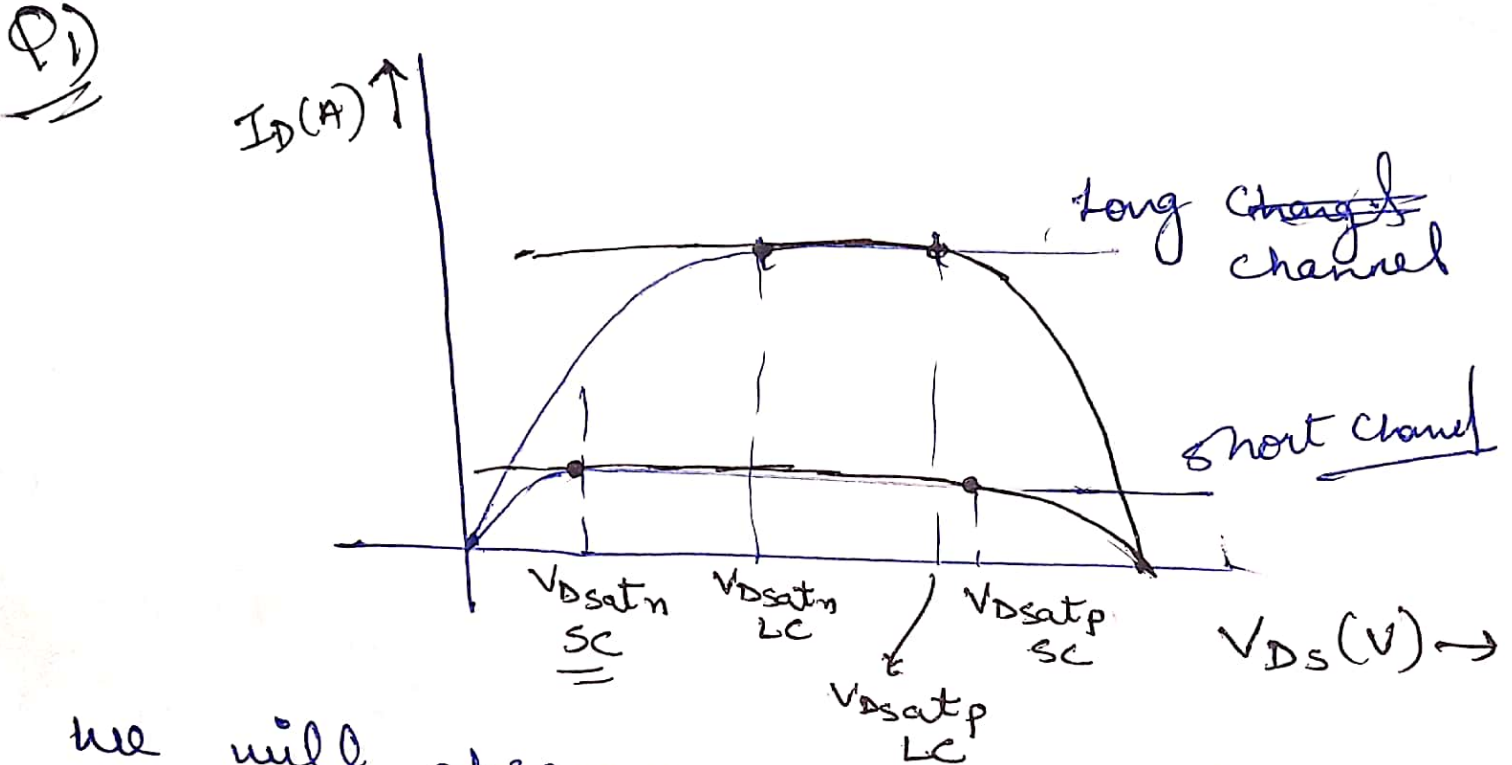


Quiz 4 Solution



we will observe a steep slope for larger values of voltage in short channel because both NMOS & PMOS in short channel attain saturation early as compared to long channel.

Q2) The sub threshold leakage current of MOSFET does not affect swing of CMOS Inverter.

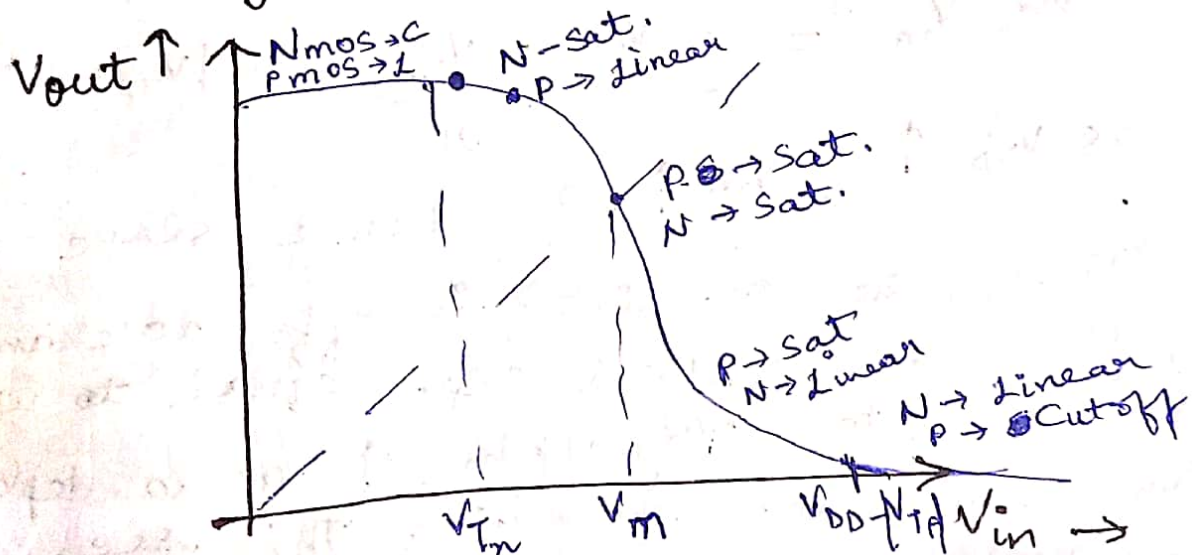
Let say, $V_{in} = \text{logic low}$,
The current flowing from PMOS will be charging load cap. while subthreshold current flowing through NMOS will be discharging it.

$I_{\text{subthreshold}} \ll I_{\text{PMOS}}$

So $V_{OH} = V_{DD}$ & $V_{OL} = 0V$

1 tank filling analogy

Q3) This Question can be answered by drawing the VTC.



a) when $V_{tn} < V_{in} \rightarrow$ NMOS \rightarrow Sat.
PMOS \rightarrow linear

$V_{in} \leq V_m \rightarrow$ NMOS \rightarrow Sat.
PMOS \rightarrow Sat.

b) $V_m \leq V_{in} \leq V_{DD} - |V_{tp}|$

\rightarrow NMOS \rightarrow linear

\rightarrow PMOS \rightarrow Sat.

Q4) For creating an PMOS, we need two heavy doped p^+ regions with n -doped body. So we need an additional n well which denotes the body of PMOS.

Q5) 1) To avoid / prevent current crowding
2) To reduce contact resistance.

Q6) Infinite, becomes finite or decreases

Q7) V_{Tn} to $V_{DD} - |V_{Tp}|$

Q8) Statement is incorrect
Increasing supply voltage \uparrow power dissipation
as $P \propto V_{DD}$

But $\uparrow V_{DD} \rightarrow \downarrow$ slope of VTC
as
$$\frac{dV_o}{dV_{in}} = g = - \frac{1 + \sqrt{\frac{K_p}{K_n}}}{(\lambda_n - \lambda_p) \left(\frac{V_m - V_j}{2} \right)}$$

Q9)
$$V_m = \frac{\mu V_{DD} + V_{Tn} - \mu |V_{Tp}|}{\mu}$$

as $V_{DD} \uparrow$, $V_m \uparrow$ & hence slope \downarrow

Q9) When $V_{GS} = 0$, transistor is off
 → no channel formation & total Cap. equal to $wL C_{ox}$ appears b/w gate & body.
 When $V_{GS} \uparrow$, a depletion region forms under the gate.
 Once the transistor enters its saturation sub threshold region, the channel starts to form and drop in C_{GCB} must be observed before V_T not exactly at V_T } *once channel forms, it shields body*
 The device operates in the resistive mode & the Cap. divides equally b/w source & drain.

$$C_{GCS} = C_{GCD} = \frac{wL C_{ox}}{2}$$

2

10)

Gate channel capacitance (C_{gc})

$$C_{gc} = C_{ox} w L + 2 C_{ox} w$$

$$C_{gc} = \frac{2}{3} C_{ox} w L + 2 C_{ox} w$$

$$\& C_{ox} = \frac{\epsilon_{ox}}{t_{ox}}$$

So clearly it can be seen that

C_{gc} does not depend on doping conc.

But we know that V_T depends upon doping and C_{gc} is a function of V_{gs} . So C_{gc} changes with doping.

even if they answered "yes"
& gave this logic \rightarrow (2)

for those
who answered
"NO" (2)